

APPROVAL SHEET

WW12C, WW08C, WW06C, WW04C, WW02C

±5%, ±1%

Low ohm chip resistors (power) Size 1206, 0805, 0603, 0402, 0201

*Contents in this sheet are subject to change without prior notice.



FEATURE

- 1. High power rating and low range
- 2. High reliability and stability
- 3. Suitable for current sensing of small mobile devices
- 4. RoHS compliant & Lead free
- 5. Up side down mounting to minimize resistance drift after soldering

APPLICATION

- Game equipment
- Mobile phone
- Battery pack
- Power supply
- DSC
- HDD

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to nominated value within tolerance which controlled by laser trimming of this resistive layer.

The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

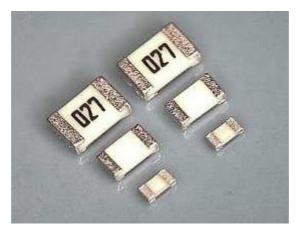


Fig 1. Construction of Chip-R



QUICK REFERENCE DATA

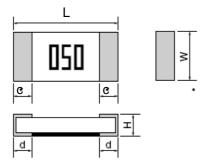
Item	General Specification				
Series No.	WW12C	WW08C	WW06C	WW04C	WW02C
Size code	1206 (3216)	0805 (2012)	0603 (1608)	0402 (1005)	0201 (0603)
Resistance Tolerance		±5%,	±1%		±5%
Resistance Range	0.020Ω ~ 0.100Ω (E24 +E96)	0.010Ω ~ 0.100Ω (E24 +E96)	0.010Ω ~ 0.100Ω (E24 +E96)	0.025Ω ~ 0.100Ω (E24 +E96)	0.020Ω ~ 0.100Ω (E24 +E96)
TCR (ppm/°C)					
$0.010\Omega \sim 0.019\Omega$	N/A	0 ~ +250 ppm	0 ~ +350 ppm	N/A	N/A
$0.020\Omega \sim 0.030\Omega$	0 ~ +250 ppm	0 ~ +250 ppm	0 ~ +350 ppm	0 ~ +350 ppm	0 ~ +350 ppm
$0.033\Omega \sim 0.050\Omega$	±100 ppm	±150 ppm	0 ~ +250 ppm	0 ~ +350 ppm	0 ~ +350 ppm
$0.051\Omega \sim 0.100\Omega$	±100 ppm	±100 ppm	±150 ppm	±150 ppm	0 ~ +350 ppm
Max. dissipation at T _{amb} =70°C	1/2W	1/3 W	1/4 W	1/8 W	1/10 W
Max. Operation Current (DC or RMS)	2.2 ~ 5.0A	1.8 ~ 5.7 A	1.5 ~ 5.0 A	1.1 ~ 2.2 A	1.0 ~ 2.2 A
Operation temperature	-55 ~ +125'C				

Note:

- 1. This is the maximum current that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2. Max. Operation current : So called RCWC (Rated Continuous Working Current) is determined by $RCWC = \sqrt{Rated\ Power\ /\ Resistance\ Value}$

MECHANICAL DATA(unit: mm)

Symbol	WW12C	WW08C	WW06C	WW04C	WW02C
L	3.10 ± 0.20	2.00 ± 0.15	1.60 ± 0.10	1.00 ± 0.05	0.60 ± 0.03
W	1.60 ± 0.15	1.25 ± 0.10	0.80 +0.15 -0.05	0.50 ± 0.05	0.30 ± 0.03
Н	0.60 ± 0.10	0.60 ± 0.10	0.50 ± 0.10	0.35 +0.05 -0.10	0.23 + 0.03 - 0.10
С	0.50 ± 0.25	0.40 ± 0.20	0.30 ± 0.10	0.25 +0.05 -0.10	0.15 +0.05 -0.10
d	0.50 ± 0.25	0.40 ± 0.20 0.60 ± 0.20 (< 0.02Ω)	0.30 ± 0.10 0.55 ± 0.10 $(< 0.02\Omega)$	0.25 +0.05 -0.10	0.15 ± 0.05





MARKING

Each resistor is marked with a three-digit code on the substrate to designate the nominal resistance value. Please refer below table list! 0603, 0402 and 0201 sizes are no marking!

Rated Resistance

Resistance	Code	Mark
20mΩ	R020	020
22mΩ	R022	022
24mΩ	R024	024
25mΩ	R025	025
27mΩ	R027	027
30mΩ	R030	030
33mΩ	B033	033
36mΩ	R036	036
39mO	B039	ന്ദര

Resistance	Code	Mark
40mΩ	R040	040
43mΩ	R043	043
47mΩ	R047	047
50mΩ	R050	050
51mΩ	R051	051
56mΩ	R056	056
60mΩ	R060	060
62mΩ	R062	062
65mΩ	R065	065

Resistance	Code	Mark
68mΩ	R068	068
$70 \text{m}\Omega$	R070	070
75mΩ	R075	075
80mΩ	R080	080
82mΩ	R082	082
$90 m\Omega$	R090	■90
91mΩ	R091	091
100mΩ	R100	R10

Example:

 $R10 = 0.100\Omega$

 $050 = 0.050\Omega$



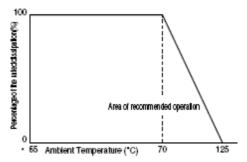
FUNCTIONAL DESCRIPTION

Product characterization

Standard values of nominal resistance are taken from the E96 & E24 series for resistors with a tolerance of \pm 5% & \pm 1%. The values of the E24/E96 series are in accordance with "IEC publication 60063".

De-rating curve

The power that the resistor can dissipate depends on the operating temperature; see Fig.2



MOUNTING

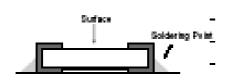
Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

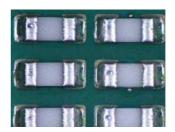
Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.

Resistive layer is on the bottom side as below!







SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 245°C during 3 seconds within lead-free solder bath. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

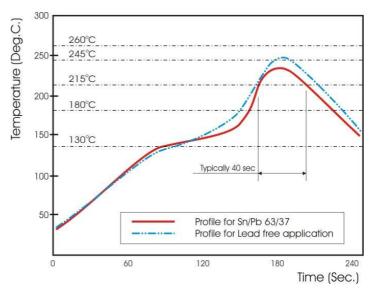


Fig 3. Infrared soldering profile for chip resistor

CATALOGUE NUMBERS

The resistors have a catalogue number starting with .

WW04	С	R050	F	Т	L
Size code	Type code	Resistance code	Tolerance	Packaging code	Termination code
WW02 : 0201	0201, 1/10W	E96 +E24:	J : ±5%	T:7" Reel taping	L = Sn base
WW04 : 0402	0402, 1/8W	R is first digit followed by 3	F : ±1%	A: 7" Reel taping	(lead free)
WW06 : 0603	0603, 1/4W	significant digits.		15Kpcs/reel	
WW08 : 0805	0805, 1/3W	$0.020\Omega = R020$			
WW12 : 1206	1206, 1/2W	$0.100\Omega = R100$			
		$0.025\Omega = R025$			
			I		

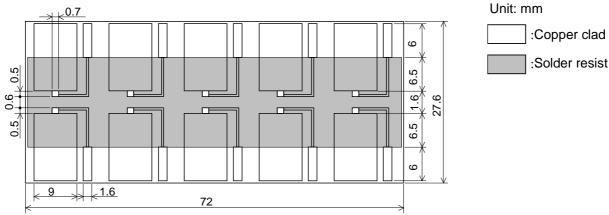
- Reeled tape packaging
 WW02C: 8mm width paper taping 2mm pitch, 15,000pcs per reel.
- Reeled tape packaging WW04C: 8mm width paper taping 2mm pitch, 10,000pcs per reel.
- Reeled tape packaging WW06C: 8mm width paper taping 4mm pitch, 5,000pcs per reel.
- Reeled tape packaging
 WW08C: 8mm width paper taping 4mm pitch, 5,000pcs per reel.
- Reeled tape packaging
 WW12C: 8mm width paper taping 4mm pitch, 5,000pcs per reel.



TEST AND REQUIREMENTS

TEST	PROCEDURE	REQUIREMENT
Temperature Coefficient of Resistance (TCR)	Natural resistance change per change in degree centigrade. $\frac{R_2-R_1}{R_1(t_2-t_1)}\!\!\times\!10^6 \text{ (ppm/°C)}$ $\text{R}_1: \text{Resistance at reference temperature}$ $\text{R}_2: \text{Resistance at test temperature}$ $\text{t}_1: 25^\circ\text{C}$	Test temperature −55 ~ +125°C As defined in P.3
Short time overload (STOL) Sub-Clause 4.13	Permanent resistance change after 2 second application of a current 2.5 times RCWC specified.	ΔR/R max. ±1% no visible damage
Resistance to soldering heat Sub-clause 4.18	Un-mounted chips 10±0.5 seconds, 260±5°C	no visible damage Δ R/R max. $\pm 1\%$
Solderability Sub-clause 4.17	Termination Sn base (lead free): Un-mounted chip completely immersed in a lead free solder bath, 235°C±5°C, 2±0.5 sec	good tinning (>95% covered) no visible damage
Temperature cycling Sub-clause 4.19	 30 minutes at -55°C±3°C, 2~3 minutes at room temperature, 30 minutes at +125°±3°C, 2~3 minutes at room temperature, Total 5 continuous cycles 	no visible damage ΔR/R max. ±1%
Load life (endurance) Sub-clause 4.25.1	70±2°C, 1000 hours, loaded with rated current, 1.5 hours on and 0.5 hours off	ΔR/R max. ±5% no visible damage
Steady state in Humidity Sub-clause 4.24	1000hrs without current applied in humidity chamber controller at 40°C±2°C and 90~95% relative humidity	ΔR/R max. ±5% no visible damage
Bending strength Sub-clause 4.33	Resistors mounted on a 90mm glass epoxy resin PCB(FR4); bending : 3 mm,	Δ R/R max. ±1% no visible damage
Adhesion Sub-clause 4.32	5N, 10±1s (WW02C: 3N)	No visible damage

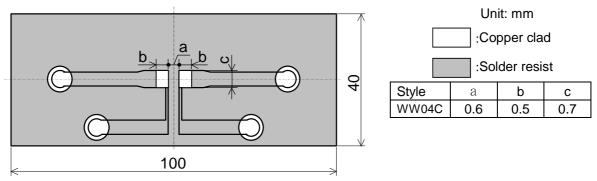




WW04C TEST SUBSTRATE Figure-3

Remarks:

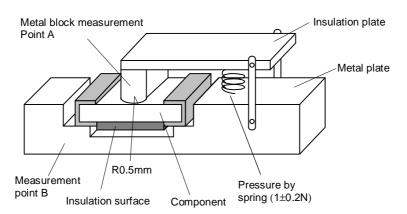
- 1). Material: Epoxy woven glass
 - Thickness: 1.6mm Thickness of copper clad: 0.035mm
- 2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.



WW04C BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE Figure-4

Remark 1). Material: Epoxy woven glass

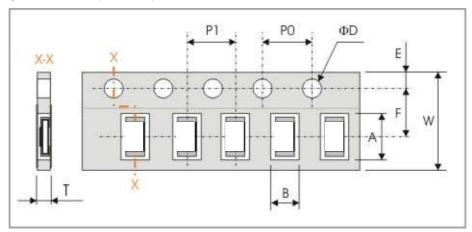
Thickness: 1.6mm Thickness of copper clad: 0.035mm





PACKAGING

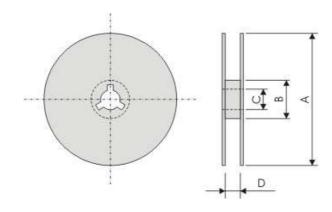
Paper Tape specifications (unit :mm)



Series No.	А	В	W	F	Е
WW02C	0.67±0.05	0.37±0.05	8.00±0.20	3.50±0.05	1.75±0.10
WW04C	1.15±0.10	0.65±0.10	8.00±0.20	3.50±0.05	1.75±0.10
WW06C	1.90±0.20	1.15±0.15	8.00±0.20	3.50±0.05	1.75±0.10
WW08C	2.50±0.20	1.65±0.15	8.00±0.20	3.50±0.05	1.75±0.10
WW12C	3.60±0.20	2.00±0.15	8.00±0.20	3.50±0.05	1.75±0.10

Series No.	P1	P0	ΦD	Т
WW02C	2.00±0.05	4.00±0.05	Φ 1.50 $^{+0.1}_{-0.0}$	0.45±0.05
WW04C	2.00±0.05	4.00±0.10	Ф1.50 ^{+0.1} _{-0.0}	Max. 0.5
WW06C	4.00±0.10	4.00±0.10	Ф1.50 ^{+0.1}	Max. 0.8
WW08C	4.00±0.10	4.00±0.10	Ф1.50 ^{+0.1}	Max. 1.0
WW12C	4.00±0.10	4.00±0.10	Ф1.50 ^{+0.1} _{-0.0}	Max. 1.0

Reel dimensions



Symbol	Α	В	С	D
(unit : mm)	Ф180.0 -1.5	Φ60.0±1.0	13.0±0.2	9.0+1.0

Mouser Electronics

Authorized Distributor

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Walsin:

<u>WW02C_FTL R020 - R100</u> <u>WW02C_JTL R020 - R100</u> <u>WW04C_FTL R020 - R030</u> <u>WW04C_FTL R033 - R100</u> <u>WW06C_FTL R033 - R100</u> <u>WW06C_JTL R033 - R100</u> <u>WW08C_FTL R015 - R030</u> <u>WW08C_FTL R033 - R100</u> <u>WW08C_JTL R020 - R030</u> <u>WW08C_JTL R033 - R100</u> <u>WW12C_FTL R021 - R100</u> <u>WW25C_FTL R020 - R100</u> <u>WW25C_JTL R020 - R100</u> <u>WW06C_FTL R010 - R030</u> <u>WW06C_JTL R010 - R030</u>